#### **FEE TRANSMITTAL**

## Electronic Version v08

Stylesheet Version v08.0

Title of Invention

METHOD OF IMPROVING ALIGNMENT FOR SEMICONDUCTOR FABRICATION

Application Number:

Date:

First Named Applicant: Tung-Liang Yang
Attorney Docket Number: NTCP0030USA

# **TOTAL FEE AUTHORIZED \$810**

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

## **BASIC FILING FEE**

Fee Description	Fee Code	Amount \$	Fee Paid \$
Utility Filing Fee	1001	770	770
	_	Subtotal Fo	r Basic Filing Fees: \$ 770

#### **EXTRA CLAIM FEES**

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$		
Total Claims : 6	0	1202	18	0		
Independent Claims : 1	0	1201	86	0		
Subtotal For Extra Claims Fees: \$ (						

### **ASSIGNMENT FEES**

Fee Description	Property Number	Quantity	Fee Code	Amount \$	Fee Paid \$		
Recording Each Patent	00000000	1	8021	40	40		
Assignment Per Property Fee							
Subtotal For Additional Fees: \$40							

## **AUTHORIZED BILLING INFORMATION**

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Deposit account number: 500801

Access Code \*\*\*\*

Deposit name: NORTH AMERICA INTERNATIONAL PATENT

**OFFICE** 

Deposit authorized name: WINSTON HSU

Signature: VAEB-JMXX-8IIL

Date (YYYYMMDD): 2004-03-30

Charge Assignment Fees Required Under 37 C.F.R. Section 1.21 (h).

Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.